LP3852/LP3855 1.5A Fast Response Ultra Low Dropout Linear Regulators

Check for Samples: LP3852, LP3855

FEATURES

- **Ultra Low Dropout Voltage**
- **Stable with Selected Ceramic Capacitors**
- **Low Ground Pin Current**
- **Load Regulation of 0.06%**
- **10nA Quiescent Current in Shutdown Mode**
- **Specified Output Current of 1.5A DC**
- **Available in TO-263, TO-220 and SOT-223 Packages**
- **Output Voltage Accuracy ± 1.5%**
- **Error Flag Indicates Output Status**
- **Sense Option Improves Load Regulation**
- **Overtemperature/Overcurrent Protection**
- **−40°C to +125°C Junction Temperature Range**

APPLICATIONS

- **Microprocessor Power Supplies**
- **GTL, GTL+, BTL, and SSTL Bus Terminators**
- **Power Supplies for DSPs**
- **SCSI Terminator**
- **Post Regulators**
- **High Efficiency Linear Regulators**
- **Battery Chargers**
- **Other Battery Powered Applications**

DESCRIPTION

The LP3852/LP3855 series of fast ultra low-dropout linear regulators operate from a +2.5V to +7.0V input supply. Wide range of preset output voltage options are available. These ultra low dropout linear regulators respond very quickly to step changes in load, which makes them suitable for low voltage microprocessor applications. The LP3852/LP3855 are developed on a CMOS process which allows low quiescent current operation independent of output load current. This CMOS process also allows the LP3852/LP3855 to operate under extremely low dropout conditions.

Dropout Voltage: Ultra low dropout voltage; typically 24mV at 150mA load current and 240mV at 1.5A load current.

Ground Pin Current: Typically 4mA at 1.5A load current.

Shutdown Mode: Typically 10nA quiescent current when the shutdown pin is pulled low.

Error Flag: Error flag goes low when the output voltage drops 10% below nominal value.

SENSE: Sense pin improves regulation at remote loads.

Precision Output Voltage: Multiple output voltage options are available ranging from 1.8V to 5.0V with a specified accuracy of ±1.5% at room temperature, and ±3.0% over all conditions (varying line, load, and temperature).

Typical Application Circuits
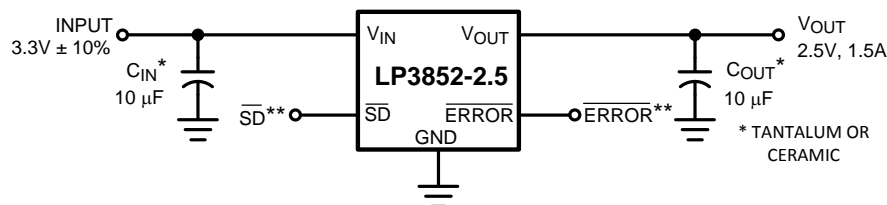
**$\overline{SD}$ and $\overline{ERROR}$ pins must be pulled high through a 10kΩ pull-up resistor. Connect the $\overline{ERROR}$ pin to ground if this function is not used. See Application Hints for more information.
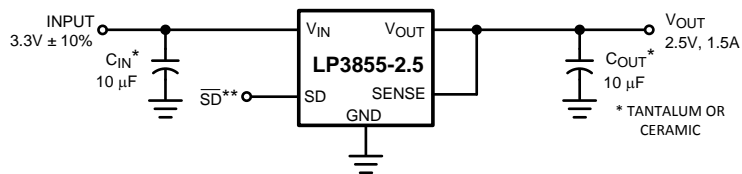
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.
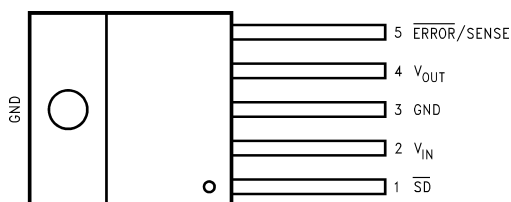All trademarks are the property of their respective owners.
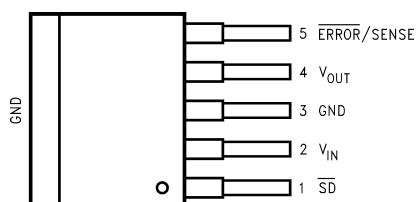
**$\overline{SD}$ must be pulled high through a 10kΩ pull-up resistor. See Application Hints for more information.

Connection Diagram

Figure 1. Top View
TO220-5 Package
Bent, Staggered Leads

Figure 2. Top View
TO263-5 Package
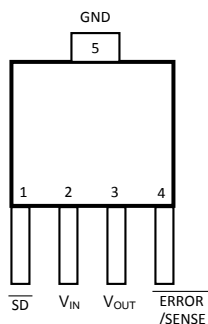
Figure 3. Top View
SOT223-5 Package

Table 1. Pin Descriptions for TO220-5 and TO263-5 Packages

Pin #	LP3852		LP3855	
	Name	**Function**	**Name**	**Function**
1	$\overline{SD}$	Shutdown	$\overline{SD}$	Shutdown
2	V_{IN}	Input Supply	V_{IN}	Input Supply
3	GND	Ground	GND	Ground
4	V_{OUT}	Output Voltage	V_{OUT}	Output Voltage
5	$\overline{ERROR}$	$\overline{ERROR}$ Flag	SENSE	Remote Sense Pin

Product Folder Links: *LP3852 LP3855*

Table 2. Pin Descriptions for SOT223-5 Package

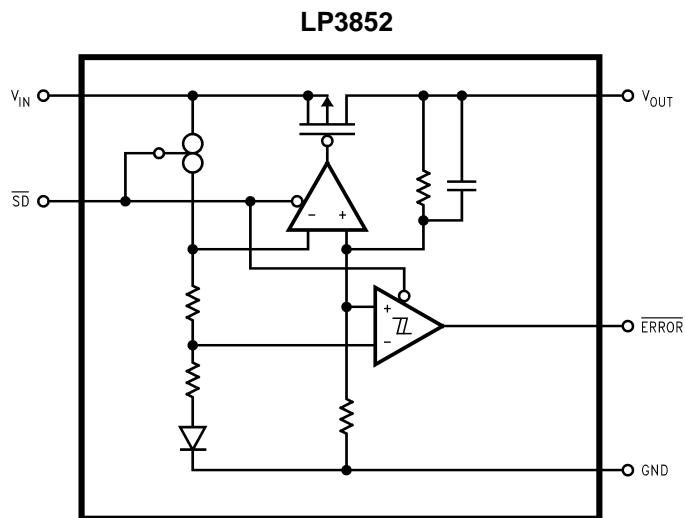| Pin #	LP3852		LP3855	
	Name	Function	Name	Function
1	$\overline{SD}$	Shutdown	$\overline{SD}$	Shutdown
2	V_{IN}	Input Supply	V_{IN}	Input Supply
3	V_{OUT}	Output Voltage	V_{OUT}	Output Voltage
4	$\overline{ERROR}$	$\overline{ERROR}$ Flag	SENSE	Remote Sense Pin
5	GND	Ground	GND	Ground

Block Diagram
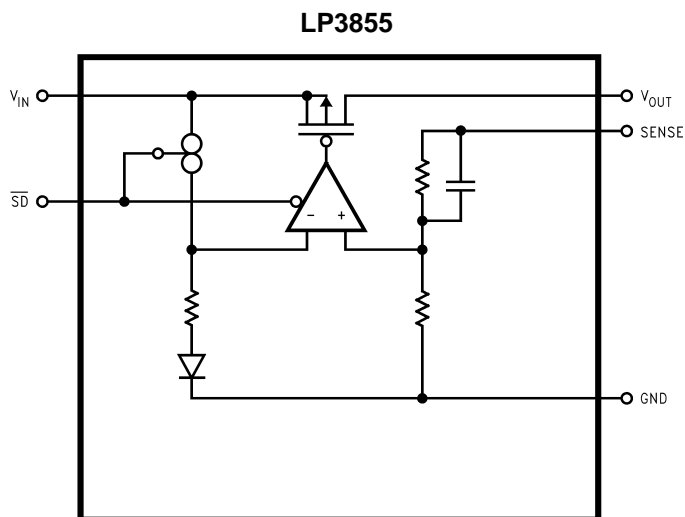
LP3852

Figure 4.

LP3855

Figure 5.

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Product Folder Links: *LP3852 LP3855*

Absolute Maximum Ratings [1]

Storage Temperature Range	−65°C to +150°C
Lead Temperature	
(Soldering, 5 sec.)	260°C
ESD Rating [2]	2 kV
Power Dissipation [3]	Internally Limited
Input Supply Voltage (Survival)	−0.3V to +7.5V
Shutdown Input Voltage (Survival)	−0.3V to 7.5V
Output Voltage (Survival), [4], [5]	−0.3V to +6.0V
I_{OUT} (Survival)	Short Circuit Protected
Maximum Voltage for $\overline{ERROR}$ Pin	V_{IN}
Maximum Voltage for SENSE Pin	V_{OUT}

(1) Absolute maximum ratings indicate limits beyond which damage to the device may occur. Operating ratings indicate conditions for which the device is intended to be functional, but does not specify performance limits. For specifications and test conditions, see Electrical Characteristics. The specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
(2) The human body model is a 100pF capacitor discharged through a 1.5kΩ resistor into each pin.
(3) At elevated temperatures, devices must be derated based on package thermal resistance. The devices in TO220 package must be derated at θ_{jA} = 50°C/W (with 0.5in^2, 1oz. copper area), junction-to-ambient (with no heat sink). The devices in the TO263 surface-mount package must be derated at θ_{jA} = 60°C/W (with 0.5in^2, 1oz. copper area), junction-to-ambient. See Application Hints.
(4) If used in a dual-supply system where the regulator load is returned to a negative supply, the output must be diode-clamped to ground.
(5) The output PMOS structure contains a diode between the V_{IN} and V_{OUT} terminals. This diode is normally reverse biased. This diode will get forward biased if the voltage at the output terminal is forced to be higher than the voltage at the input terminal. This diode can typically withstand 200mA of DC current and 1Amp of peak current.

Operating Ratings

Input Supply Voltage [1]	2.5V to 7.0V
Shutdown Input Voltage	−0.3V to 7.0V
Maximum Operating Current (DC)	1.5A
Junction Temperature	−40°C to +125°C

(1) The minimum operating value for V_{IN} is equal to either [$V_{OUT(NOM)}$ + $V_{DROPOUT}$] or 2.5V, whichever is greater.

Product Folder Links: *LP3852 LP3855*

Electrical Characteristics
LP3852/LP3855

Limits in standard typeface are for T_J = 25°C, and limits in **boldface type** apply over the **full operating temperature range**.
Unless otherwise specified: V_{IN} = $V_{O(NOM)}$ + 1V, I_L = 10 mA, C_{OUT} = 10μF, V_{SD} = 2V.

Symbol	Parameter	Conditions	Typ [1]	LP3852/5 [2]		Units
				Min	**Max**	
V_O	Output Voltage Tolerance [3]	V_{OUT} +1V ≤ V_{IN} ≤ 7.0V 10 mA ≤ I_L ≤ 1.5A	0	-1.5 **-3.0**	+1.5 **+3.0**	%
ΔV_{OL}	Output Voltage Line Regulation [3]	V_{OUT} +1V ≤ V_{IN} ≤ 7.0V	0.02 **0.06**			%
$\Delta V_O / \Delta I_{OUT}$	Output Voltage Load Regulation [3]	10 mA ≤ I_L ≤ 1.5A	0.06 **0.12**			%
V_{IN} - V_{OUT}	Dropout Voltage TO-263 and TO-220 [4]	I_L = 150 mA	24		35 **45**	mV
		I_L = 1.5A	240		280 **380**	
	Dropout Voltage SOT 223 [4], [5]	I_L = 150mA	26		35 **45**	
		I_L = 1.5A	260		320 **435**	
I_{GND}	Ground Pin Current In Normal Operation Mode	I_L = 150 mA	3		9 **10**	mA
		I_L = 1.5A	3		9 **10**	
I_{GND}	Ground Pin Current In Shutdown Mode	V_{SD} ≤ 0.3V	0.01		10	μA
		-40°C ≤ T_J ≤ 85°C			**50**	
$I_{O(PK)}$	Peak Output Current	V_O ≥ $V_{O(NOM)}$ - 4%	1.8			A
Short Circuit Protection						
I_{SC}	Short Circuit Current		3.2			A
Shutdown Input						
V_{SDT}	Shutdown Threshold	V_{SDT} Rising from 0.3V until Output = ON	1.3	**2**		V
		V_{SDT} Falling from 2.0V until Output = OFF	1.3		**0.3**	
T_{dOFF}	Turn-off delay	I_L = 1.5A	20			μs
T_{dON}	Turn-on delay	I_L = 1.5A	25			μs
I_{SD}	$\overline{SD}$ Input Current	V_{SD} = V_{IN}	1			nA
$\overline{Error Flag}$						
V_T	Threshold	[6]	10	**5**	**16**	%
V_{TH}	Threshold Hysteresis	[6]	5	**2**	**8**	%
$V_{EF(Sat)}$	$\overline{Error Flag}$ Saturation	I_{sink} = 100μA	0.02		**0.1**	V
Td	Flag Reset Delay		1			μs
I_{lk}	$\overline{Error Flag}$ Pin Leakage Current		1			nA
I_{max}	$\overline{Error Flag}$ Pin Sink Current	V_{Error} = **0.5V**	1			mA
AC Parameters						

(1) Typical numbers are at 25°C and represent the most likely parametric norm.
(2) Limits are spedified by testing, design, or statistical correlation.
(3) Output voltage line regulation is defined as the change in output voltage from the nominal value due to change in the input line voltage. Output voltage load regulation is defined as the change in output voltage from the nominal value due to change in load current. The line and load regulation specification contains only the typical number. However, the limits for line and load regulation are included in the output voltage tolerance specification.
(4) Dropout voltage is defined as the minimum input to output differential voltage at which the output drops 2% below the nominal value. Dropout voltage specification applies only to output voltages of 2.5V and above. For output voltages below 2.5V, the drop-out voltage is nothing but the input to output differential, since the minimum input voltage is 2.5V.
(5) The SOT 223 package devices have slightly higher dropout due to increased bond wire resistance.
(6) $\overline{Error Flag}$ threshold and hysteresis are specified as percentage of regulated output voltage. See Application Hints.

Electrical Characteristics
LP3852/LP3855 (continued)

Limits in standard typeface are for T_J = 25°C, and limits in **boldface type** apply over the **full operating temperature range**. Unless otherwise specified: V_{IN} = $V_{O(NOM)}$ + 1V, I_L = 10 mA, C_{OUT} = 10µF, V_{SD} = 2V.

Symbol	Parameter	Conditions	Typ [1]	LP3852/5 [2]		Units
				Min	Max	
PSRR	Ripple Rejection	V_{IN} = V_{OUT} + 1V C_{OUT} = 10uF V_{OUT} = 3.3V, f = 120Hz	73			dB
		V_{IN} = V_{OUT} + 0.5V C_{OUT} = 10uF V_{OUT} = 3.3V, f = 120Hz	57			
$\rho_{n(l/f)}$	Output Noise Density	f = 120Hz	0.8			µV
e_n	Output Noise Voltage	BW = 10Hz – 100kHz V_{OUT} = 2.5V	150			µV (rms)
		BW = 300Hz – 300kHz V_{OUT} = 2.5V	100			

Product Folder Links: *LP3852 LP3855*

Typical Performance Characteristics

Unless otherwise specified: T_J = 25°C, C_{OUT} = 10µF, C_{IN} = 10µF, S/D pin is tied to V_{IN}, V_{OUT} = 2.5V, V_{IN} = $V_{O(NOM)}$ + 1V, I_L = 10 mA.

Dropout Voltage vs Output Load Current

Figure 6.

Ground Current vs Output Voltage I_L = 1.5A

Figure 7.

Shutdown I_Q vs Junction Temperature

Figure 8.

Errorflag Threshold vs Junction Temperature

Figure 9.

DC Load Reg. vs Junction Temperature

Figure 10.

DC Line Regulation vs Temperature
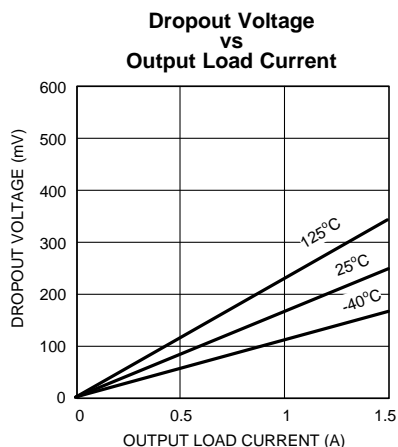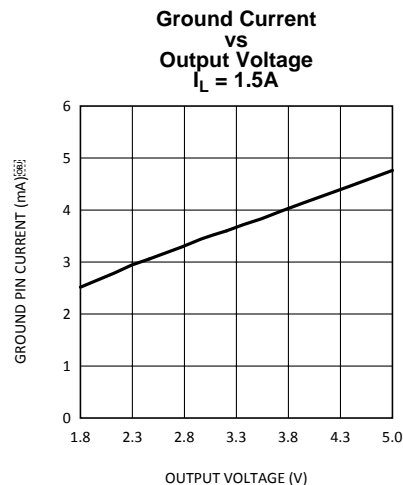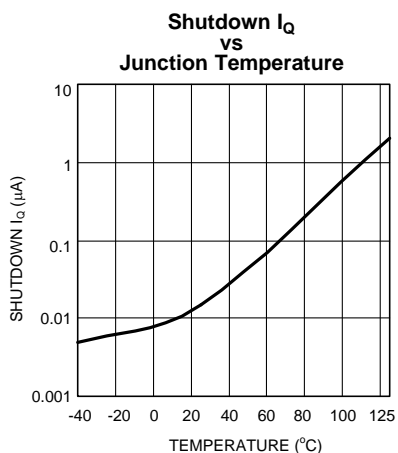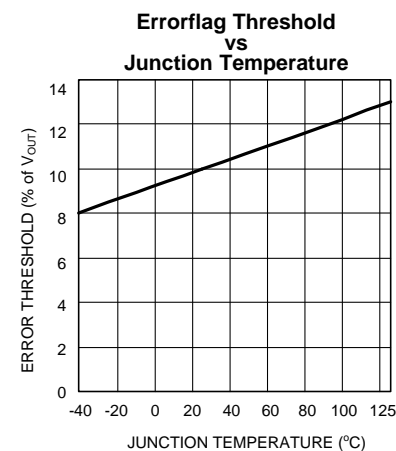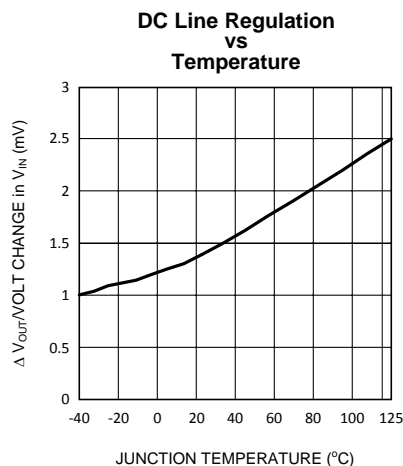
Figure 11.

Typical Performance Characteristics (continued)

Unless otherwise specified: $T_J = 25°C$, $C_{OUT} = 10µF$, $C_{IN} = 10µF$, S/D pin is tied to V_{IN}, $V_{OUT} = 2.5V$, $V_{IN} = V_{O(NOM)} + 1V$, $I_L = 10 mA$.

V_{IN} vs V_{OUT} Over Temperature

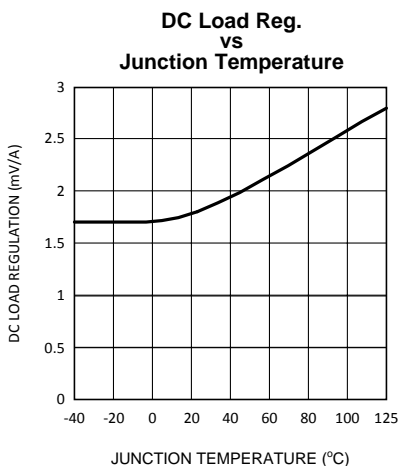**Figure 12.**

Noise vs Frequency

Figure 13.

Load Transient Response
$C_{IN} = C_{OUT} = 10µF$, OSCON

Figure 14.

Load Transient Response
$C_{IN} = C_{OUT} = 100µF$, OSCON

Figure 15.

Load Transient Response
$C_{IN} = C_{OUT} = 100µF$, POSCAP

Figure 16.

Load Transient Response
$C_{IN} = C_{OUT} = 10µF$, TANTALUM

Figure 17.

Product Folder Links: *LP3852 LP3855*

Typical Performance Characteristics (continued)

Unless otherwise specified: T_J = 25°C, C_{OUT} = 10µF, C_{IN} = 10µF, S/D pin is tied to V_{IN}, V_{OUT} = 2.5V, V_{IN} = $V_{O(NOM)}$ + 1V, I_L = 10 mA.

Load Transient Response
C_{IN} = C_{OUT} = 100µF, TANTALUM

Figure 18.

Load Transient Response
C_{IN} = 2 x 10µF CERAMIC
C_{OUT} = 2 x 10µF CERAMIC

Figure 19.

Load Transient Response
C_{IN} = 2 x 10µF CERAMIC
C_{OUT} = 2 x 10µF CERAMIC
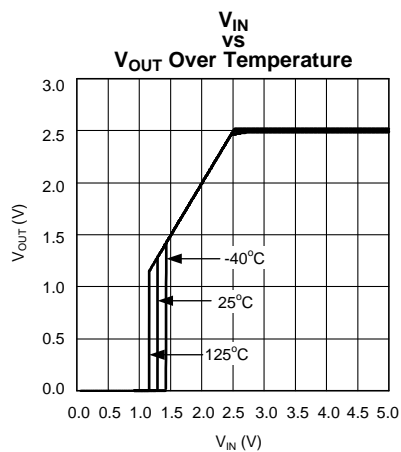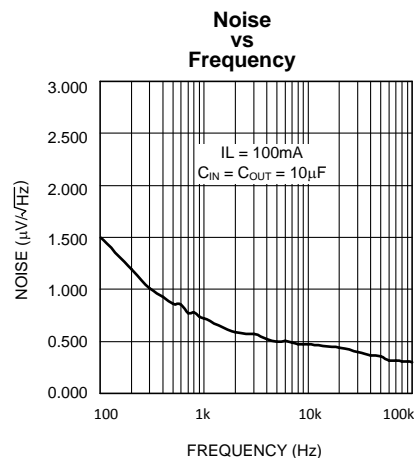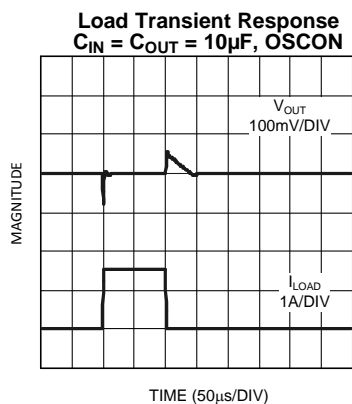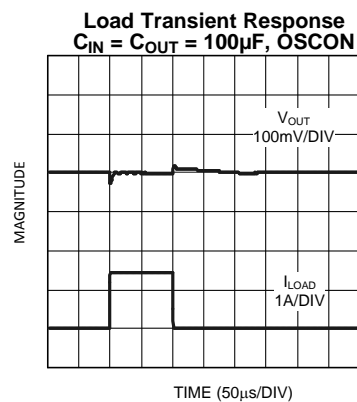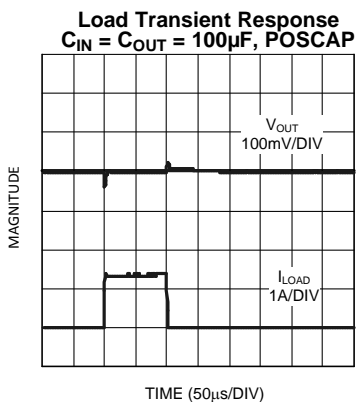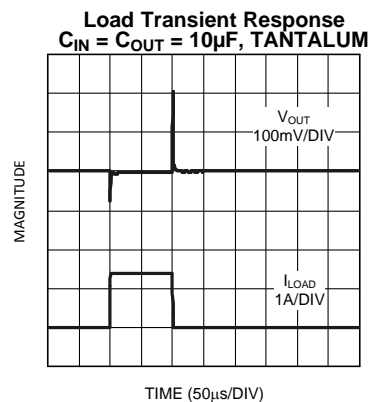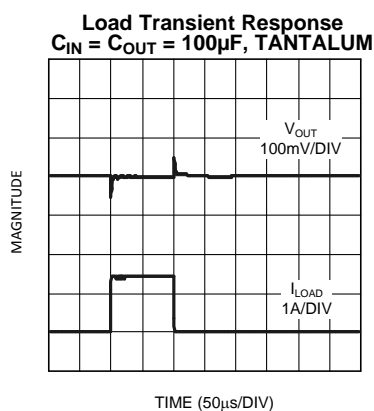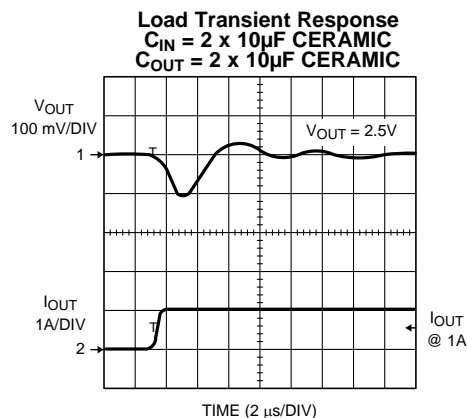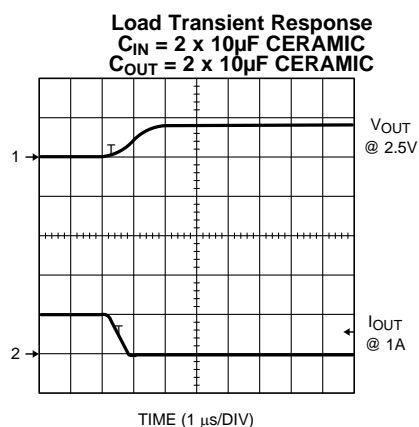
Figure 20.

Application Hints

EXTERNAL CAPACITORS

Like any low-dropout regulator, external capacitors are required to assure stability. these capacitors must be correctly selected for proper performance.

INPUT CAPACITOR: An input capacitor of at least 10µF is required. Ceramic or Tantalum may be used, and capacitance may be increased without limit

OUTPUT CAPACITOR: An output capacitor is required for loop stability. It must be located less than 1 cm from the device and connected directly to the output and ground pins using traces which have no other currents flowing through them (see PCB Layout section).

The minimum amount of output capacitance that can be used for stable operation is 10µF. For general usage across all load currents and operating conditions, the part was characterized using a 10µF Tantalum input capacitor. The minimum and maximum stable ESR range for the output capacitor was then measured which kept the device stable, assuming any output capacitor whose value is greater than 10µF (see Figure 21 below).
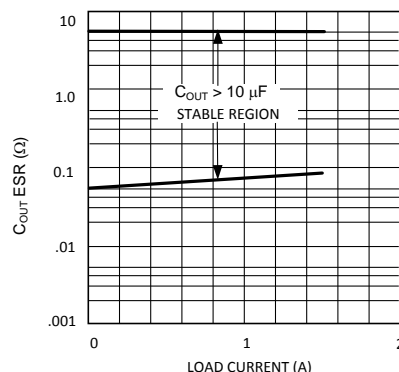
Figure 21. ESR Curve for C$_{OUT}$ (with 10µF Tantalum Input Capacitor)

It should be noted that it is possible to operate the part with an output capacitor whose ESR is below these limits, assuming that sufficient ceramic input capacitance is provided. This will allow stable operation using ceramic output capacitors (see next section).

OPERATION WITH CERAMIC OUTPUT CAPACITORS

LP385X voltage regulators can operate with ceramic output capacitors if the values of the input and output capacitors are selected appropriately. The total ceramic output capacitance must be equal to or less than a specified maximum value in order for the regulator to remain stable over all operating conditions. This maximum amount of ceramic output capacitance is dependent upon the amount of ceramic input capacitance used as well as the load current of the application. This relationship is shown in Figure 22, which graphs the maximum stable value of ceramic output capacitance as a function of ceramic input capacitance for load currents of 1.5A.
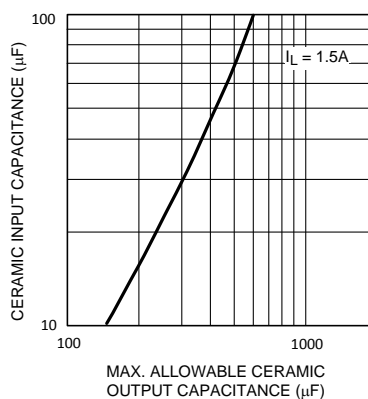
Figure 22. Maximum Ceramic Output Capacitance vs Ceramic Input Capacitance

If the maximum load current is 1.5A and a 10µF ceramic input capacitor is used, the regulator will be stable with ceramic output capacitor values from 10µF up to about 150µF. When calculating the total ceramic output capacitance present in an application, it is necessary to include any ceramic bypass capacitors connected to the regulator output.

SELECTING A CAPACITOR

It is important to note that capacitance tolerance and variation with temperature must be taken into consideration when selecting a capacitor so that the minimum required amount of capacitance is provided over the full operating temperature range. In general, a good Tantalum capacitor will show very little capacitance variation with temperature, but a ceramic may not be as good (depending on dielectric type). Aluminum electrolytics also typically have large temperature variation of capacitance value.

Product Folder Links: *LP3852 LP3855*

Equally important to consider is a capacitor's ESR change with temperature: this is not an issue with ceramics, as their ESR is extremely low. However, it is very important in Tantalum and aluminum electrolytic capacitors. Both show increasing ESR at colder temperatures, but the increase in aluminum electrolytic capacitors is so severe they may not be feasible for some applications (see Capacitor Characteristics Section).

CAPACITOR CHARACTERISTICS

CERAMIC: For values of capacitance in the 10 to 100 µF range, ceramics are usually larger and more costly than tantalums but give superior AC performance for bypassing high frequency noise because of very low ESR (typically less than 10 mΩ). However, some dielectric types do not have good capacitance characteristics as a function of voltage and temperature.

Z5U and Y5V dielectric ceramics have capacitance that drops severely with applied voltage. A typical Z5U or Y5V capacitor can lose 60% of its rated capacitance with half of the rated voltage applied to it. The Z5U and Y5V also exhibit a severe temperature effect, losing more than 50% of nominal capacitance at high and low limits of the temperature range.

X7R and X5R dielectric ceramic capacitors are strongly recommended if ceramics are used, as they typically maintain a capacitance range within ±20% of nominal over full operating ratings of temperature and voltage. Of course, they are typically larger and more costly than Z5U/Y5U types for a given voltage and capacitance.

TANTALUM: Solid Tantalum capacitors are typically recommended for use on the output because their ESR is very close to the ideal value required for loop compensation.

Tantalums also have good temperature stability: a good quality Tantalum will typically show a capacitance value that varies less than 10-15% across the full temperature range of 125°C to −40°C. ESR will vary only about 2X going from the high to low temperature limits.

The increasing ESR at lower temperatures can cause oscillations when marginal quality capacitors are used (if the ESR of the capacitor is near the upper limit of the stability range at room temperature).

ALUMINUM: This capacitor type offers the most capacitance for the money. The disadvantages are that they are larger in physical size, not widely available in surface mount, and have poor AC performance (especially at higher frequencies) due to higher ESR and ESL.

Compared by size, the ESR of an aluminum electrolytic is higher than either Tantalum or ceramic, and it also varies greatly with temperature. A typical aluminum electrolytic can exhibit an ESR increase of as much as 50X when going from 25°C down to −40°C.

It should also be noted that many aluminum electrolytics only specify impedance at a frequency of 120 Hz, which indicates they have poor high frequency performance. Only aluminum electrolytics that have an impedance specified at a higher frequency (between 20 kHz and 100 kHz) should be used for the LP385X. Derating must be applied to the manufacturer's ESR specification, since it is typically only valid at room temperature.

Any applications using aluminum electrolytics should be thoroughly tested at the lowest ambient operating temperature where ESR is maximum.

TURN-ON CHARACTERISTICS FOR OUTPUT VOLTAGES PROGRAMMED TO 2.0V OR BELOW

As Vin increases during start-up, the regulator output will track the input until Vin reaches the minimum operating voltage (typically about 2.2V). For output voltages programmed to 2.0V or below, the regulator output may momentarily exceed its programmed output voltage during start up. Outputs programmed to voltages above 2.0V are not affected by this behavior.

PCB LAYOUT

Good PC layout practices must be used or instability can be induced because of ground loops and voltage drops. The input and output capacitors must be directly connected to the input, output, and ground pins of the regulator using traces which do not have other currents flowing in them (Kelvin connect).

The best way to do this is to lay out C_{IN} and C_{OUT} near the device with short traces to the V_{IN}, V_{OUT}, and ground pins. The regulator ground pin should be connected to the external circuit ground so that the regulator and its capacitors have a "single point ground".

It should be noted that stability problems have been seen in applications where "vias" to an internal ground plane were used at the ground points of the IC and the input and output capacitors. This was caused by varying ground potentials at these nodes resulting from current flowing through the ground plane. Using a single point ground technique for the regulator and it's capacitors fixed the problem.

Since high current flows through the traces going into V_{IN} and coming from V_{OUT}, Kelvin connect the capacitor leads to these pins so there is no voltage drop in series with the input and output capacitors.

RFI/EMI SUSCEPTIBILITY

RFI (radio frequency interference) and EMI (electromagnetic interference) can degrade any integrated circuit's performance because of the small dimensions of the geometries inside the device. In applications where circuit sources are present which generate signals with significant high frequency energy content (> 1 MHz), care must be taken to ensure that this does not affect the IC regulator.

If RFI/EMI noise is present on the input side of the regulator (such as applications where the input source comes from the output of a switching regulator), good ceramic bypass capacitors must be used at the input pin of the IC.

If a load is connected to the IC output which switches at high speed (such as a clock), the high-frequency current pulses required by the load must be supplied by the capacitors on the IC output. Since the bandwidth of the regulator loop is less than 100 kHz, the control circuitry cannot respond to load changes above that frequency. This means the effective output impedance of the IC at frequencies above 100 kHz is determined only by the output capacitor(s).

In applications where the load is switching at high speed, the output of the IC may need RF isolation from the load. It is recommended that some inductance be placed between the output capacitor and the load, and good RF bypass capacitors be placed directly across the load.

PCB layout is also critical in high noise environments, since RFI/EMI is easily radiated directly into PC traces. Noisy circuitry should be isolated from "clean" circuits where possible, and grounded through a separate path. At MHz frequencies, ground planes begin to look inductive and RFI/EMI can cause ground bounce across the ground plane.

In multi-layer PCB applications, care should be taken in layout so that noisy power and ground planes do not radiate directly into adjacent layers which carry analog power and ground.

OUTPUT NOISE

Noise is specified in two ways-

Spot Noise or **Output noise density** is the RMS sum of all noise sources, measured at the regulator output, at a specific frequency (measured with a 1Hz bandwidth). This type of noise is usually plotted on a curve as a function of frequency.

Total output Noise or **Broad-band noise** is the RMS sum of spot noise over a specified bandwidth, usually several decades of frequencies.

Attention should be paid to the units of measurement. Spot noise is measured in units µV/√Hz or nV/√Hz and total output noise is measured in µV(rms).

The primary source of noise in low-dropout regulators is the internal reference. In CMOS regulators, noise has a low frequency component and a high frequency component, which depend strongly on the silicon area and quiescent current. Noise can be reduced in two ways: by increasing the transistor area or by increasing the current drawn by the internal reference. Increasing the area will decrease the chance of fitting the die into a smaller package. Increasing the current drawn by the internal reference increases the total supply current (ground pin current). Using an optimized trade-off of ground pin current and die size, LP3852/LP3855 achieves low noise performance and low quiescent current operation.

The total output noise specification for LP3852/LP3855 is presented in the Electrical Characteristics table. The Output noise density at different frequencies is represented by a curve under typical performance characteristics.

SHORT-CIRCUIT PROTECTION

The LP3852 and LP3855 are short circuit protected and in the event of a peak over-current condition, the short-circuit control loop will rapidly drive the output PMOS pass element off. Once the power pass element shuts down, the control loop will rapidly cycle the output on and off until the average power dissipation causes the thermal shutdown circuit to respond to servo the on/off cycling to a lower frequency. Please refer to the section on thermal information for power dissipation calculations.

$\overline{\text{ERROR}}$ FLAG OPERATION

The LP3852/LP3855 produces a logic low signal at the $\overline{\text{Error}}$ Flag pin when the output drops out of regulation due to low input voltage, current limiting, or thermal limiting. This flag has a built in hysteresis. The timing diagram in Figure 23 shows the relationship between the $\overline{\text{ERROR}}$ flag and the output voltage. In this example, the input voltage is changed to demonstrate the functionality of the Error Flag.

The internal $\overline{\text{Error}}$ flag comparator has an open drain output stage. Hence, the $\overline{\text{ERROR}}$ pin should be pulled high through a pull up resistor. Although the $\overline{\text{ERROR}}$ flag pin can sink current of 1mA, this current is energy drain from the input supply. Hence, the value of the pull up resistor should be in the range of 10kΩ to 1MΩ. **The ERROR pin must be connected to ground if this function is not used.** It should also be noted that when the shutdown pin is pulled low, the $\overline{\text{ERROR}}$ pin is forced to be invalid for reasons of saving power in shutdown mode.
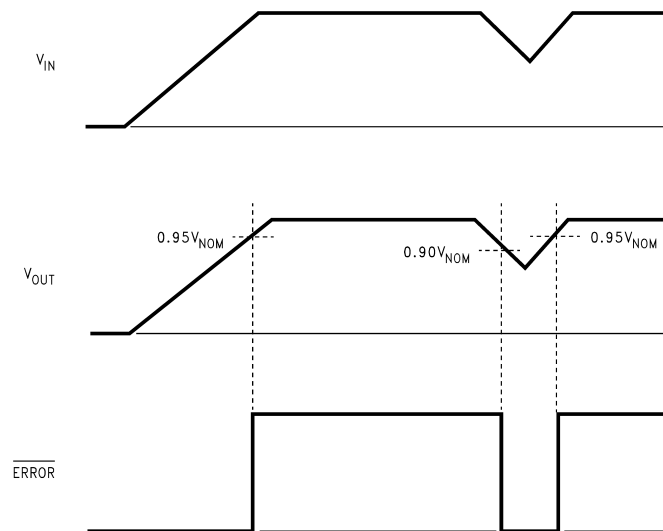
Figure 23. $\overline{\text{Error}}$ Flag Operation

SENSE PIN

In applications where the regulator output is not very close to the load, LP3855 can provide better remote load regulation using the SENSE pin. Figure 24 depicts the advantage of the SENSE option. LP3852 regulates the voltage at the output pin. Hence, the voltage at the remote load will be the regulator output voltage minus the drop across the trace resistance. For example, in the case of a 3.3V output, if the trace resistance is 100mΩ, the voltage at the remote load will be 3.15V with 1.5A of load current, I_{LOAD}. The LP3855 regulates the voltage at the sense pin. Connecting the sense pin to the remote load will provide regulation at the remote load, as shown in Figure 24. If the sense option pin is not required, the sense pin must be connected to the V_{OUT} pin.
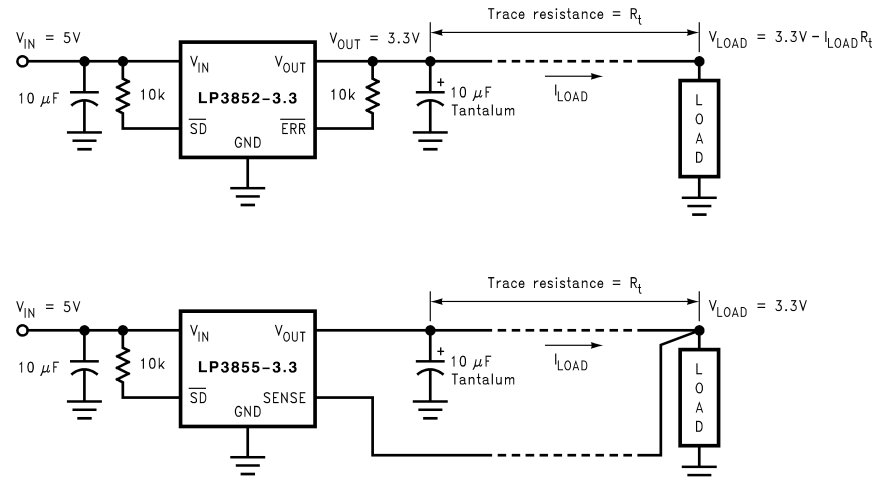
Figure 24. Improving remote load regulation using LP3855

SHUTDOWN OPERATION

A CMOS Logic low level signal at the shutdown ($\overline{SD}$) pin will turn-off the regulator. Pin $\overline{SD}$ must be actively terminated through a 10kΩ pull-up resistor for a proper operation. If this pin is driven from a source that actively pulls high and low (such as a CMOS rail to rail comparator), the pull-up resistor is not required. This pin must be tied to Vin if not used.

The Shutdown ($\overline{SD}$) pin threshold has no voltage hysteresis. If the Shutdown pin is actively driven, the voltage transition must rise and fall cleanly and promptly.

DROPOUT VOLTAGE

The dropout voltage of a regulator is defined as the minimum input-to-output differential required to stay within 2% of the nominal output voltage. For CMOS LDOs, the dropout voltage is the product of the load current and the Rds(on) of the internal MOSFET.

REVERSE CURRENT PATH

The internal MOSFET in LP3852 and LP3855 has an inherent parasitic diode. During normal operation, the input voltage is higher than the output voltage and the parasitic diode is reverse biased. However, if the output is pulled above the input in an application, then current flows from the output to the input as the parasitic diode gets forward biased. The output can be pulled above the input as long as the current in the parasitic diode is limited to 200mA continuous and 1A peak.

POWER DISSIPATION/HEATSINKING

LP3852 and LP3855 can deliver a continuous current of 1.5A over the full operating temperature range. A heatsink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. Under all possible conditions, the junction temperature must be within the range specified under operating conditions. The total power dissipation of the device is given by:

$$P_D = (V_{IN} - V_{OUT})I_{OUT} + (V_{IN})I_{GND}$$

where I_{GND} is the operating ground current of the device (specified under Electrical Characteristics).

The maximum allowable temperature rise (T_{Rmax}) depends on the maximum ambient temperature (T_{Amax}) of the application, and the maximum allowable junction temperature (T_{Jmax}):

$$T_{Rmax} = T_{Jmax} - T_{Amax}$$

The maximum allowable value for junction to ambient Thermal Resistance, θ_{JA}, can be calculated using the formula:

$$\theta_{JA} = T_{Rmax} / P_D$$

Product Folder Links: *LP3852 LP3855*

LP3852 and LP3855 are available in TO-220 and TO-263 packages. The thermal resistance depends on amount of copper area or heat sink, and on air flow. If the maximum allowable value of θ_{JA} calculated above is ≥ 60 °C/W for TO-220 package and ≥ 60 °C/W for TO-263 package no heatsink is needed since the package can dissipate enough heat to satisfy these requirements. If the value for allowable θ_{JA} falls below these limits, a heat sink is required.

HEATSINKING TO-220 PACKAGE

The thermal resistance of a TO220 package can be reduced by attaching it to a heat sink or a copper plane on a PC board. If a copper plane is to be used, the values of θ_{JA} will be same as shown in next section for TO263 package.

The heatsink to be used in the application should have a heatsink to ambient thermal resistance,

$\theta_{HA} \leq \theta_{JA} - \theta_{CH} - \theta_{JC}$.

In this equation, θ_{CH} is the thermal resistance from the case to the surface of the heat sink and θ_{JC} is the thermal resistance from the junction to the surface of the case. θ_{JC} is about 3°C/W for a TO220 package. The value for θ_{CH} depends on method of attachment, insulator, etc. θ_{CH} varies between 1.5°C/W to 2.5°C/W. If the exact value is unknown, 2°C/W can be assumed.

HEATSINKING TO-263 PACKAGE

The TO-263 package uses the copper plane on the PCB as a heatsink. The tab of these packages are soldered to the copper plane for heat sinking. Figure 25 shows a curve for the θ_{JA} of TO-263 package for different copper area sizes, using a typical PCB with 1 ounce copper and no solder mask over the copper area for heat sinking.
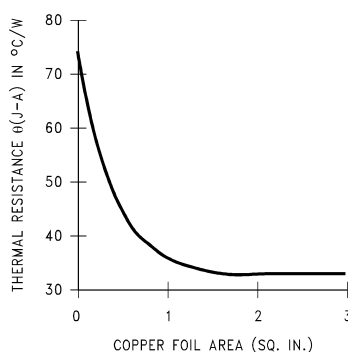
Figure 25. θ_{JA} vs Copper (1 Ounce) Area for TO-263 package

As shown in the figure, increasing the copper area beyond 1 square inch produces very little improvement. The minimum value for θ_{JA} for the TO-263 package mounted to a PCB is 32°C/W.

Figure 26 shows the maximum allowable power dissipation for TO-263 packages for different ambient temperatures, assuming θ_{JA} is 35°C/W and the maximum junction temperature is 125°C.

Figure 26. Maximum power dissipation vs ambient temperature for TO-263 package

PACKAGING INFORMATION

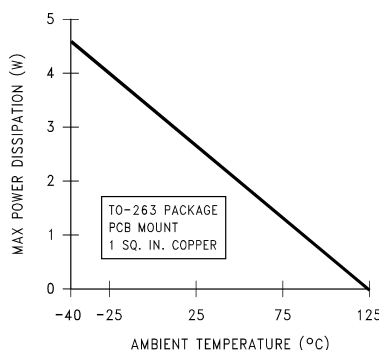| Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3852EMP-1.8	ACTIVE	SOT-223	NDC	5	1000	TBD	Call TI	Call TI	-40 to 125	LHTB	Samples
LP3852EMP-1.8/NOPB	ACTIVE	SOT-223	NDC	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHTB	Samples
LP3852EMP-2.5	ACTIVE	SOT-223	NDC	5	1000	TBD	Call TI	Call TI	-40 to 125	LHUB	Samples
LP3852EMP-2.5/NOPB	ACTIVE	SOT-223	NDC	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHUB	Samples
LP3852EMP-3.3	ACTIVE	SOT-223	NDC	5	1000	TBD	Call TI	Call TI	-40 to 125	LHVB	Samples
LP3852EMP-3.3/NOPB	ACTIVE	SOT-223	NDC	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHVB	Samples
LP3852EMP-5.0	ACTIVE	SOT-223	NDC	5	1000	TBD	Call TI	Call TI	-40 to 125	LHXB	Samples
LP3852EMP-5.0/NOPB	ACTIVE	SOT-223	NDC	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHXB	Samples
LP3852EMPX-1.8	ACTIVE	SOT-223	NDC	5	2000	TBD	Call TI	Call TI	-40 to 125	LHTB	Samples
LP3852EMPX-1.8/NOPB	ACTIVE	SOT-223	NDC	5	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHTB	Samples
LP3852EMPX-2.5	ACTIVE	SOT-223	NDC	5	2000	TBD	Call TI	Call TI	-40 to 125	LHUB	Samples
LP3852EMPX-2.5/NOPB	ACTIVE	SOT-223	NDC	5	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHUB	Samples
LP3852EMPX-3.3	ACTIVE	SOT-223	NDC	5	2000	TBD	Call TI	Call TI	-40 to 125	LHVB	Samples
LP3852EMPX-3.3/NOPB	ACTIVE	SOT-223	NDC	5	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHVB	Samples
LP3852EMPX-5.0	ACTIVE	SOT-223	NDC	5	2000	TBD	Call TI	Call TI	-40 to 125	LHXB	Samples
LP3852EMPX-5.0/NOPB	ACTIVE	SOT-223	NDC	5	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHXB	Samples
LP3852ES-1.8	ACTIVE	DDPAK/ TO-263	KTT	5	45	TBD	Call TI	Call TI	-40 to 125	LP3852ES -1.8	Samples
LP3852ES-1.8/NOPB	ACTIVE	DDPAK/ TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3852ES -1.8	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3852ES-2.5	ACTIVE	DDPAK/TO-263	KTT	5	45	TBD	Call TI	Call TI	-40 to 125	LP3852ES-2.5	Samples
LP3852ES-2.5/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3852ES-2.5	Samples
LP3852ES-3.3	ACTIVE	DDPAK/TO-263	KTT	5	45	TBD	Call TI	Call TI	-40 to 125	LP3852ES-3.3	Samples
LP3852ES-3.3/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3852ES-3.3	Samples
LP3852ES-5.0	ACTIVE	DDPAK/TO-263	KTT	5	45	TBD	Call TI	Call TI	-40 to 125	LP3852ES-5.0	Samples
LP3852ES-5.0/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3852ES-5.0	Samples
LP3852ESX-1.8	ACTIVE	DDPAK/TO-263	KTT	5	500	TBD	Call TI	Call TI	-40 to 125	LP3852ES-1.8	Samples
LP3852ESX-1.8/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3852ES-1.8	Samples
LP3852ESX-2.5	ACTIVE	DDPAK/TO-263	KTT	5	500	TBD	Call TI	Call TI	-40 to 125	LP3852ES-2.5	Samples
LP3852ESX-2.5/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3852ES-2.5	Samples
LP3852ESX-3.3	ACTIVE	DDPAK/TO-263	KTT	5	500	TBD	Call TI	Call TI	-40 to 125	LP3852ES-3.3	Samples
LP3852ESX-3.3/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3852ES-3.3	Samples
LP3852ESX-5.0	ACTIVE	DDPAK/TO-263	KTT	5	500	TBD	Call TI	Call TI	-40 to 125	LP3852ES-5.0	Samples
LP3852ESX-5.0/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3852ES-5.0	Samples
LP3852ET-1.8	ACTIVE	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP3852ET-1.8	Samples
LP3852ET-1.8/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP3852ET-1.8	Samples
LP3852ET-2.5	ACTIVE	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP3852ET-2.5	Samples
LP3852ET-2.5/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP3852ET-2.5	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3852ET-3.3	ACTIVE	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP3852ET -3.3	Samples
LP3852ET-3.3/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP3852ET -3.3	Samples
LP3852ET-5.0	ACTIVE	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP3852ET -5.0	Samples
LP3852ET-5.0/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP3852ET -5.0	Samples
LP3855EMP-1.8	ACTIVE	SOT-223	NDC	5	1000	TBD	Call TI	Call TI	-40 to 125	LHYB	Samples
LP3855EMP-1.8/NOPB	ACTIVE	SOT-223	NDC	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHYB	Samples
LP3855EMP-2.5	ACTIVE	SOT-223	NDC	5	1000	TBD	Call TI	Call TI	-40 to 125	LHZB	Samples
LP3855EMP-2.5/NOPB	ACTIVE	SOT-223	NDC	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHZB	Samples
LP3855EMP-3.3	ACTIVE	SOT-223	NDC	5	1000	TBD	Call TI	Call TI	-40 to 125	LJ1B	Samples
LP3855EMP-3.3/NOPB	ACTIVE	SOT-223	NDC	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LJ1B	Samples
LP3855EMP-5.0	ACTIVE	SOT-223	NDC	5	1000	TBD	Call TI	Call TI	-40 to 125	LJ2B	Samples
LP3855EMP-5.0/NOPB	ACTIVE	SOT-223	NDC	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LJ2B	Samples
LP3855EMPX-1.8	ACTIVE	SOT-223	NDC	5	2000	TBD	Call TI	Call TI	-40 to 125	LHYB	Samples
LP3855EMPX-1.8/NOPB	ACTIVE	SOT-223	NDC	5	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHYB	Samples
LP3855EMPX-2.5	ACTIVE	SOT-223	NDC	5	2000	TBD	Call TI	Call TI	-40 to 125	LHZB	Samples
LP3855EMPX-2.5/NOPB	ACTIVE	SOT-223	NDC	5	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LHZB	Samples
LP3855EMPX-3.3	ACTIVE	SOT-223	NDC	5	2000	TBD	Call TI	Call TI	-40 to 125	LJ1B	Samples
LP3855EMPX-3.3/NOPB	ACTIVE	SOT-223	NDC	5	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LJ1B	Samples
LP3855EMPX-5.0	ACTIVE	SOT-223	NDC	5	2000	TBD	Call TI	Call TI	-40 to 125	LJ2B	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3855EMPX-5.0/NOPB	ACTIVE	SOT-223	NDC	5	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LJ2B	Samples
LP3855ES-1.8	ACTIVE	DDPAK/TO-263	KTT	5	45	TBD	Call TI	Call TI	-40 to 125	LP3855ES-1.8	Samples
LP3855ES-1.8/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3855ES-1.8	Samples
LP3855ES-2.5	ACTIVE	DDPAK/TO-263	KTT	5	45	TBD	Call TI	Call TI	-40 to 125	LP3855ES-2.5	Samples
LP3855ES-2.5/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3855ES-2.5	Samples
LP3855ES-3.3	ACTIVE	DDPAK/TO-263	KTT	5	45	TBD	Call TI	Call TI	-40 to 125	LP3855ES-3.3	Samples
LP3855ES-3.3/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3855ES-3.3	Samples
LP3855ES-5.0	ACTIVE	DDPAK/TO-263	KTT	5	45	TBD	Call TI	Call TI	-40 to 125	LP3855ES-5.0	Samples
LP3855ES-5.0/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3855ES-5.0	Samples
LP3855ESX-1.8	ACTIVE	DDPAK/TO-263	KTT	5	500	TBD	Call TI	Call TI	-40 to 125	LP3855ES-1.8	Samples
LP3855ESX-1.8/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3855ES-1.8	Samples
LP3855ESX-2.5	ACTIVE	DDPAK/TO-263	KTT	5	500	TBD	Call TI	Call TI	-40 to 125	LP3855ES-2.5	Samples
LP3855ESX-2.5/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3855ES-2.5	Samples
LP3855ESX-3.3	ACTIVE	DDPAK/TO-263	KTT	5	500	TBD	Call TI	Call TI	-40 to 125	LP3855ES-3.3	Samples
LP3855ESX-3.3/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3855ES-3.3	Samples
LP3855ESX-5.0	ACTIVE	DDPAK/TO-263	KTT	5	500	TBD	Call TI	Call TI	-40 to 125	LP3855ES-5.0	Samples
LP3855ESX-5.0/NOPB	ACTIVE	DDPAK/TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP3855ES-5.0	Samples
LP3855ET-1.8	ACTIVE	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP3855ET-1.8	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3855ET-1.8/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP3855ET -1.8	Samples
LP3855ET-2.5	ACTIVE	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP3855ET -2.5	Samples
LP3855ET-2.5/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP3855ET -2.5	Samples
LP3855ET-3.3	ACTIVE	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP3855ET -3.3	Samples
LP3855ET-3.3/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP3855ET -3.3	Samples
LP3855ET-5.0	ACTIVE	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP3855ET -5.0	Samples
LP3855ET-5.0/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP3855ET -5.0	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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![Texas Instruments logo] **PACKAGE MATERIALS INFORMATION**

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP3852EMP-1.8	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMP-1.8/NOPB	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMP-2.5	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMP-2.5/NOPB	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMP-3.3	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMP-3.3/NOPB	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMP-5.0	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMP-5.0/NOPB	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMPX-1.8	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMPX-1.8/NOPB	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMPX-2.5	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMPX-2.5/NOPB	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMPX-3.3	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMPX-3.3/NOPB	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMPX-5.0	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852EMPX-5.0/NOPB	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3852ESX-1.8	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP3852ESX-1.8/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3852ESX-2.5	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3852ESX-2.5/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3852ESX-3.3	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3852ESX-3.3/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3852ESX-5.0	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3852ESX-5.0/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3855EMP-1.8	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMP-1.8/NOPB	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMP-2.5	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMP-2.5/NOPB	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMP-3.3	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMP-3.3/NOPB	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMP-5.0	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMP-5.0/NOPB	SOT-223	NDC	5	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMPX-1.8	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMPX-1.8/NOPB	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMPX-2.5	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMPX-2.5/NOPB	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMPX-3.3	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMPX-3.3/NOPB	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMPX-5.0	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855EMPX-5.0/NOPB	SOT-223	NDC	5	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LP3855ESX-1.8	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3855ESX-1.8/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3855ESX-2.5	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3855ESX-2.5/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3855ESX-3.3	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3855ESX-3.3/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3855ESX-5.0	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP3855ESX-5.0/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP3852EMP-1.8	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3852EMP-1.8/NOPB	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3852EMP-2.5	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3852EMP-2.5/NOPB	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3852EMP-3.3	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3852EMP-3.3/NOPB	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3852EMP-5.0	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3852EMP-5.0/NOPB	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3852EMPX-1.8	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3852EMPX-1.8/NOPB	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3852EMPX-2.5	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3852EMPX-2.5/NOPB	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3852EMPX-3.3	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3852EMPX-3.3/NOPB	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3852EMPX-5.0	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3852EMPX-5.0/NOPB	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3852ESX-1.8	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3852ESX-1.8/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3852ESX-2.5	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3852ESX-2.5/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP3852ESX-3.3	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3852ESX-3.3/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3852ESX-5.0	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3852ESX-5.0/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3855EMP-1.8	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3855EMP-1.8/NOPB	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3855EMP-2.5	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3855EMP-2.5/NOPB	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3855EMP-3.3	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3855EMP-3.3/NOPB	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3855EMP-5.0	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3855EMP-5.0/NOPB	SOT-223	NDC	5	1000	349.0	337.0	45.0
LP3855EMPX-1.8	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3855EMPX-1.8/NOPB	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3855EMPX-2.5	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3855EMPX-2.5/NOPB	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3855EMPX-3.3	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3855EMPX-3.3/NOPB	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3855EMPX-5.0	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3855EMPX-5.0/NOPB	SOT-223	NDC	5	2000	354.0	340.0	35.0
LP3855ESX-1.8	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3855ESX-1.8/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3855ESX-2.5	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3855ESX-2.5/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3855ESX-3.3	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3855ESX-3.3/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3855ESX-5.0	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP3855ESX-5.0/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0

NDH0005D

0.110 ± 0.010
2.79 ± 0.25

ϕ $\dfrac{0.151 \pm 0.002}{3.84 \pm 0.05}$

$0.400 \begin{smallmatrix}+0.015\\-0.005\end{smallmatrix}$
$10.16 \begin{smallmatrix}+0.38\\-0.13\end{smallmatrix}$

$\dfrac{0.035 \pm 0.005}{0.89 \pm 0.13}$ TYP

$\dfrac{0.067 \pm 0.005}{1.70 \pm 0.13}$ TYP

$\dfrac{0.340 \pm 0.010}{8.64 \pm 0.25}$

PIN ONE ID

$\dfrac{0.250 \pm 0.010}{6.35 \pm 0.25}$

$\dfrac{0.134 \pm 0.015}{3.40 \pm 0.38}$

$0.015 \begin{smallmatrix}+0.010\\-0.002\end{smallmatrix}$
$0.38 \begin{smallmatrix}+0.25\\-0.05\end{smallmatrix}$

TAPERED SIDES 1°

0.343
0.324
8.70
8.24

$\dfrac{0.180 \pm 0.005}{4.57 \pm 0.13}$

0.105
2.67

SEATING PLANE

$\dfrac{0.050 \pm 0.002}{1.27 \pm 0.05}$

0.622
15.80

0.704
17.88

$\dfrac{0.176 \pm 0.009}{4.47 \pm 0.23}$

TO5D (REV A)

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NDC0005A

3.0±0.1

SYMM

⊕ 0.1Ⓜ C AⓈ BⓈ

5

B

6.96 +0.33 / -0.25

3.56 +0.15 / -0.25

1

1.5 TYP

4

A

6.5±0.2

(3.3)

(1.5)

(6.3)

(1.5 TYP)

(1 TYP)

SYMM

(1.5)

LAND PATTERN RECOMMENDATION

1.55-1.80

(1.6)

⌒ 0.1 C

0.025-0.100 TYP

0.74 +0.05 / -0.08 TYP

⊕ 0.1Ⓜ C AⓈ BⓈ

DIMENSIONS ARE IN MILLIMETERS

R0.15±0.05 TYP

R0.15±0.05 TYP

0.3 +0.03 / -0.07

0.9 MIN TYP

(1.7)

SEATING PLANE

0.25
GAGE PLANE

C

0°-10° TYP

MP05A (Rev A)

KTT0005B

10° ±3° TYP

5

4X .067
[1.7]

.270±.010
[6.86±0.25]

.400⁺·⁰¹⁰₋·₀₀₅
[10.16⁺⁰·²⁵₋₀·₁₂]

5X .028-.038
[0.71-0.97]

1

⊕ .010 [0.25]Ⓜ C AⓂ BⓂ

A

B

.340±.010
[8.64±0.25]

PIN 1 ID

.050 MAX
[1.27]

7°   7°

R.030 MAX TYP
[0.76]

.015-.030
[0.38-0.76]

.030
[0.76]   GAGE PLANE

.180⁺·⁰⁰³₋·₀₀₅
[4.57⁺⁰·⁰⁸₋₀·₁₃]

C

.006 [0.15]

.004 [0.1]

.050±.002
[1.27±0.05]

0°-6°

0°-6°

TAPPERED
SIDE 1°

.000-.006
[0-0.15]
NOTE 4

.078
[1.98]

.565   MAX
[14.35]

.200 MIN
[5.08]

.200 MIN
[5.08]

BOTTOM SIDE OF PACKAGE

(.558)
[14.17]

(.275)
[6.99]

(5X .042)
[1.07]

(.425)
[10.8]

(.328)
[8.33]

(4X .067)
[1.7]

(.075)
[1.91]

(5X .085)
[2.16]

LAND PATTERN RECOMMENDATION

CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS
DIMENSIONS IN ( ) FOR REFERENCE ONLY

TS5B (Rev D)

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